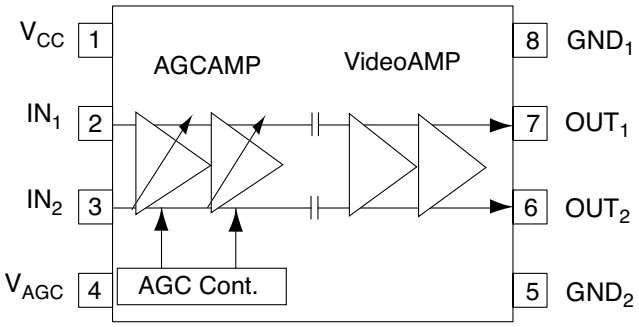
NEC's GENERAL PURPOSE 5 V AGC AMPLIFIER

UPC3221GV

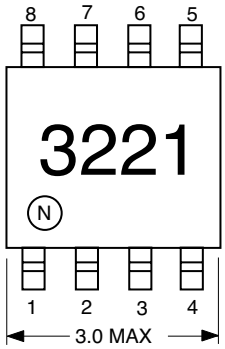
FEATURES

- **ON-CHIP LOW DISTORTION AMPLIFIER:** IIP_3 = +2.5 dBm at minimum gain
- **WIDE AGC DYNAMIC RANGE:** GCR = 50 dB TYP
- **ON-CHIP VIDEO AMPLIFIER:** V_{OUT} = 1.0 V_{P-P} at single-ended output
- **SUPPLY VOLTAGE:** V_{CC} = 5 V
- **PACKAGED IN 8 PIN SSOP SUITABLE FOR SURFACE MOUNTING**
- **LOW NOISE FIGURE:** 4.2 dB TYP

INTERNAL BLOCK DIAGRAM AND PIN CONFIGURATION



PACKAGE OUTLINE S08



All dimensions are typical unless specified otherwise.

DESCRIPTION

NEC's UPC3221GV is a Silicon Monolithic IC designed for use as an AGC Amplifier for digital CATV, cable modem and IP telephony systems. This IC consists of a two stage gain control amplifier and a fixed gain video amplifier. The device provides a differential input and differential output for noise performance, which eliminates shielding requirements.

The package is 8-pin SSOP (Shrink Small Outline Package) suitable for surface mount.

This IC is manufactured using NEC's 10 GHz f_T NESAT™ II AL silicon bipolar process. This process uses silicon nitride passivation film. This material can protect chip surface from external pollution and prevent corrosion/migration. Thus, this IC has excellent performance, uniformity and reliability.

NEC's stringent quality assurance and test procedures ensure the highest reliability and performance.

APPLICATIONS

- Digital CATV
- Cable modem receivers
- IP Telephony receivers

ELECTRICAL CHARACTERISTICS

(T_A = 25°C, V_{CC} = 5 V, Z_S = 1KΩ, Z_L = 1KΩ, f_{IN} = 45 MHz, single-ended output), unless otherwise noted

PART NUMBER / PACKAGE OUTLINE			UPC3221GV S08		
SYMBOLS	**PARAMETERS AND CONDITIONS**	**UNITS**	**MIN**	**TYP**	**MAX**
DC Characteristics					
I_{CC}	Circuit Current[1] (no input signal)	mA	26	33	41
I_{AGC} (H)	AGC Pin Current[1], No input Signal, V_{AGC} = 3.5 V	V	–	16	50
V_{AGC} (H)	AGC Voltage High Level[1], at Maximum gain	V	3.0	–	3.5
V_{AGC} (L)	AGC Voltage Low Level[1], at Minimum gain	V	0	–	0.5
RF Characteristics					
G_{MAX}	Maximum Gain[1] , VAGC = 3.0 V, P_{in} = -60 dBm	dB	57	60	63
$G_{MID}1$	Middle Gain 1[1], VAGC = 2.2 V, P_{in} = -60 dBm	dB	47.5	50.5	53.5

ELECTRICAL CHARACTERISTICS, cont.

(T_A = 25°C, V_{CC} = 5 V, f_{IN} = 45 MHz, Z_S = 50Ω, Z_L = 250Ω,single-ended output), unless otherwise noted

PART NUMBER / PACKAGE OUTLINE			UPC3221GV S08		
SYMBOLS	**PARAMETERS AND CONDITIONS**	**UNITS**	**MIN**	**TYP**	**MAX**
RF Characteristics					
$G_{MID}2$	Middle Gain 2[1], VAGC = 1.2 V, PIN = -30 dBm	dB	18	21	24
G_{MIN}	Minimum Gain[1], VAGC = 0.5 V, PIN = -30 dBm	dB	6	10	14
G_{CRin}	Gain Control Range Input[1], V_{AGC} = 0.5 to 3.0 V	dB	43	50	–
G_{CRout}	Gain Control Range Output[1], V_{out} = 1.0 V_{p-p}	dB	36	40	–
G_{slope}	Gain Control Slope[1], Gain (at V_{AGC} = 2.2 V) - Gain (at V_{AGC} = 1.2 V)	dB	26.5	29.5	32.5
V_{oclip}	Maximum Output Voltage[1], V_{AGC} = 3.0 V at maximum gain	V_{P-P}	2.0	2.8	–
NF	Noise Figure[3], V_{AGC} = 3.0 V at maximum gain	dB	–	4.2	5.7
IM_3 1	Third Order Intermodulation Distortion[1], f_{IN1} = 44 MHz, f_{IN2} = 45 MHz, PIN = -30 dBm/tone, Vout = 0.7 V_{p-p}/tone at single ended output, Z_L = 250 Ω	dBc	43	47	–
IM_3 2	Third Order Intermodulation Distortion[1] 2, fI_{N1} = 44 MHz, f_{IN2} = 45 MHz, V_{AGC} = 3.0 V at maximum gain, Vout = 0.7 V_{p-p}/tone at single ended output, Z_L = 250 Ω	dBc	50	56	–
ΔG	Gain[1,2], V_{AGC} = 3.0 V, P_{in} = -60 dBm, Z_L = 250 Ω, ΔG = G at, P_{out}1-G at P_{out}2	dB	-0.5	0	+0.5

STANDARD CHARACTERISTICS (T_A = 25°C, V_{CC} = 5 V, Z_S = 50Ω), unless otherwise noted

PART NUMBER / PACKAGE OUTLINE		UPC3221GV S08	
SYMBOLS	**PARAMETERS**	**UNITS**	**REFERENCE VALUE**
NF2	GAIN Recuction[3] = -10 dB	dB	6.0
NF3	GAIN Recuction[3] = -20 dB	dB	9.5
V_{out}	P_{in}[1] = -56 to –16 dBm	V_{p-p}	1.0
Z_{in}	Input Impedance[4] = 0.5 V, f = 45 MHz	Ω	0.9k - j1.4k
Z_{out}	Output Impedance[4] = 0.5 V, f = 45 MHz	Ω	9.0+j1.9
IIP_3	3rd Order Input Intercept Point[1] = V_{AGC} = 0.5 V at minmum gain, f_1 = 44 MHz, f_2 = 45 MHz, Z_L = 250 Ω at single ended output	dBm	+2.5

Note:
1. By measurement Circuit 1
2. By measurement Circuit 2
3. By measurement Circuit 3
4. By measurement Circuit 4

ABSOLUTE MAXIMUM RATINGS[1,2]

(T_A = 25°C, V_{CC} = 5 V, Z_S = 50 Ω, unless otherwise specified)

SYMBOLS	PARAMETERS	UNITS	RATINGS
V_{CC}	Voltage Current	V	6.0
V_{AGC} (H)	AGC Voltage	V	0 to V_{CC}
P_D	Power Dissipation[2]	mW	250
T_A	Operating Ambient Temp.[1]	°C	-40 to +85
T_{STG}	Operating Ambient Temp.[1]	°C	-55 to +150

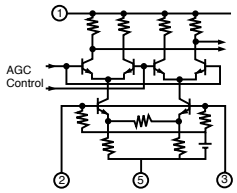
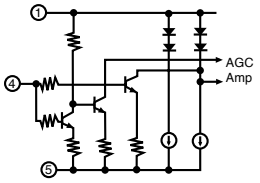
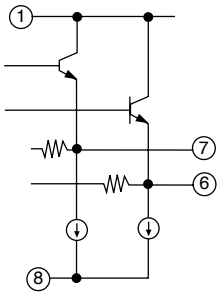
Notes:
1. Operation in excess of any one of these parameters may result in permanent damage.
2. Mounted on a 50 x 50 x 1.6 mm epoxy glass PWB, with copper patterning on both sides, T_A = 85°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	UNITS	MIN	TYP	MAX
V_{CC}	Supply Voltage	V	4.5	5.0	5.5
T_A	Operating Ambient Temp.[1]	°C	-40	+25	+85
V_{AGC}	Gain Control Voltage Range	V	0	–	3.5
f_{BW}	Video Input Signal Range	dBmV	10	45	100

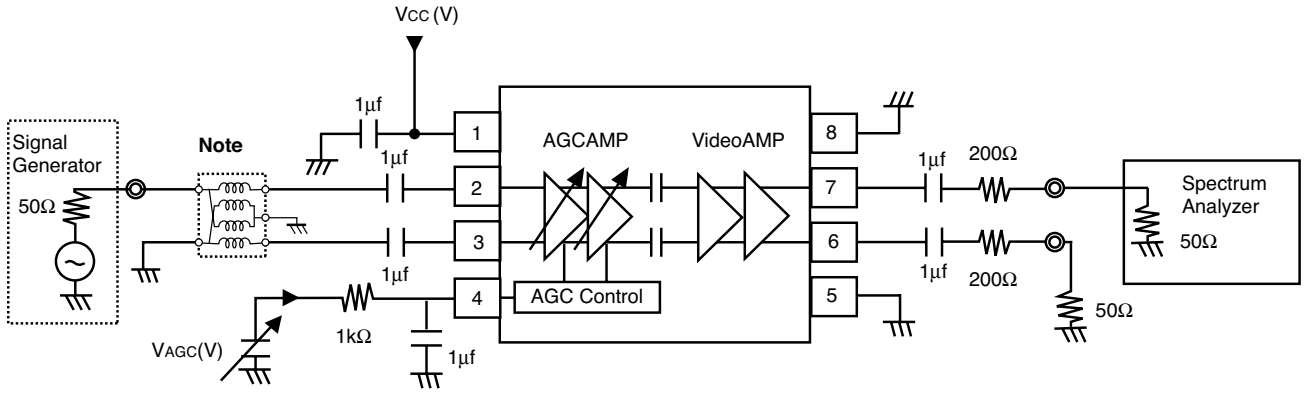
Note:
1. V_{CC} = 4.5 to 5.5 V

PIN EXPLANATIONS

Pin No.	Name	Applied Voltage (v)	Pin Voltage (v)[1]	Description	Internal Equivalent Circuit
1	V_{CC}	4.5 to 5.5		Power supply pin. This pin should be externally equipped with bypass capacitor to minimize ground impedance.	
2	INPUT1		1.29	Signal input pins of AGC amplifier.	
3	INPUT2		1.29		
4	V_{AGC}	0 to V_{CC}		Gain control pin. This pin's bias govern the AGC output level. Minimuim Gain at V_{AGC} = 0.5 V Maximum Gain at V_{AGC} = 3 to 3.5 V Recommended to use by dividing AGC voltage with external resistor (ex. 1kΩ)	
5	GND 2	0		Ground pin. This pin should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible.	
6	OUTPUT2		2.28	Signal output pins of video amplifier	
7	OUTPUT1		2.28		
8	GND 1	0		Ground pin. This pin should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible. All ground pins must be connected together with wide ground pattern to decrease impedance difference.	

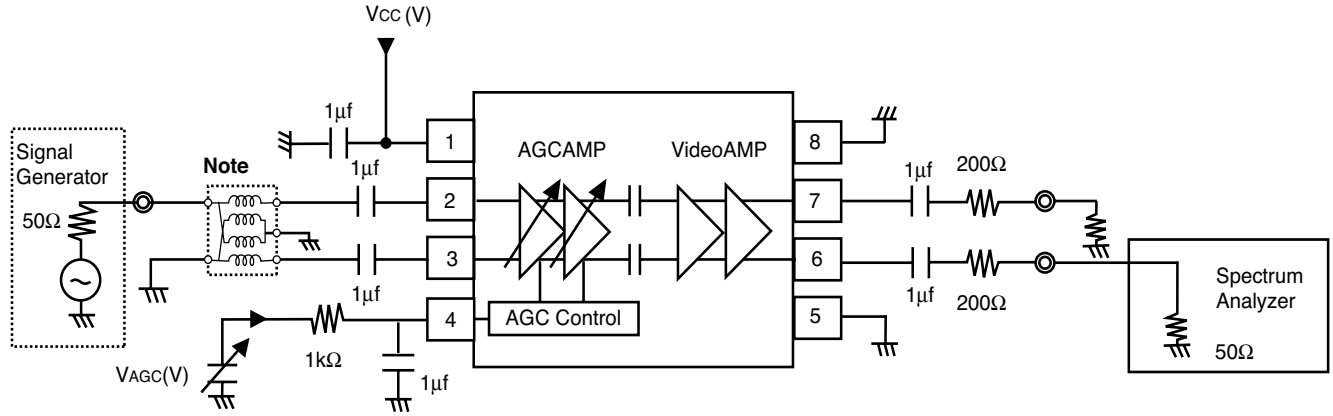
Note:
1. P_{IN} is measured at V_{CC} = 5 V

MEASUREMENT CIRCUIT 1



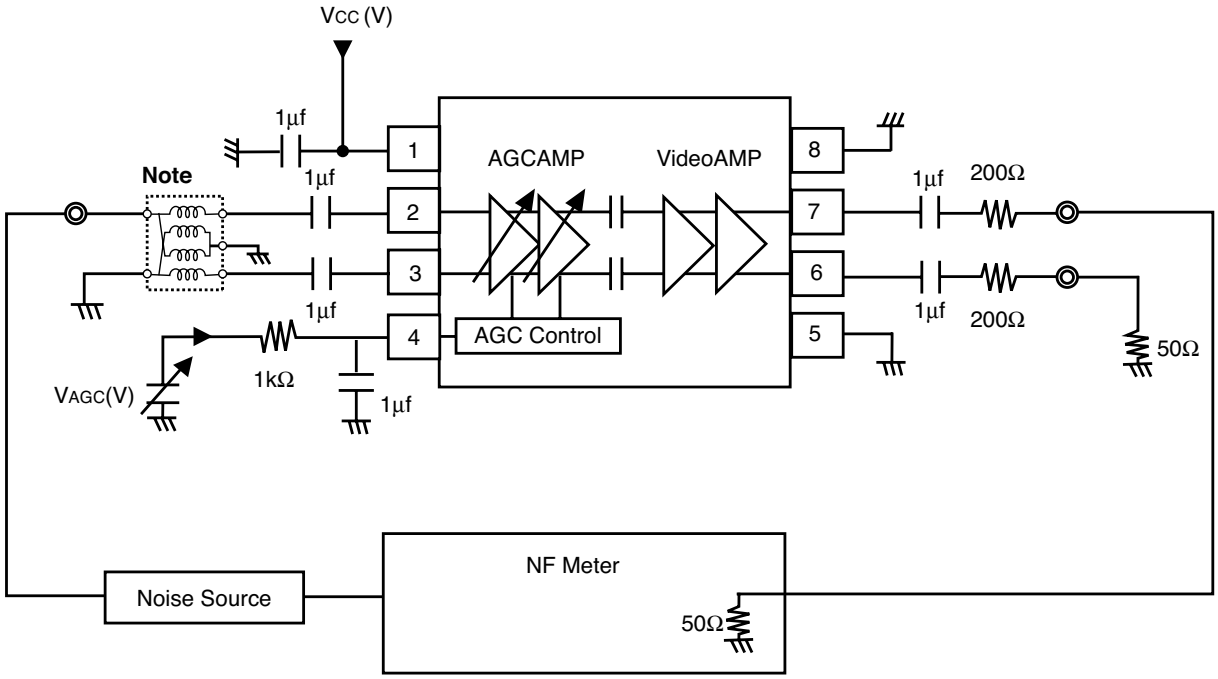
Note: Balun Transformer : TOKO 617DB-1010 B4F (Double balanced type)

MEASUREMENT CIRCUIT 2



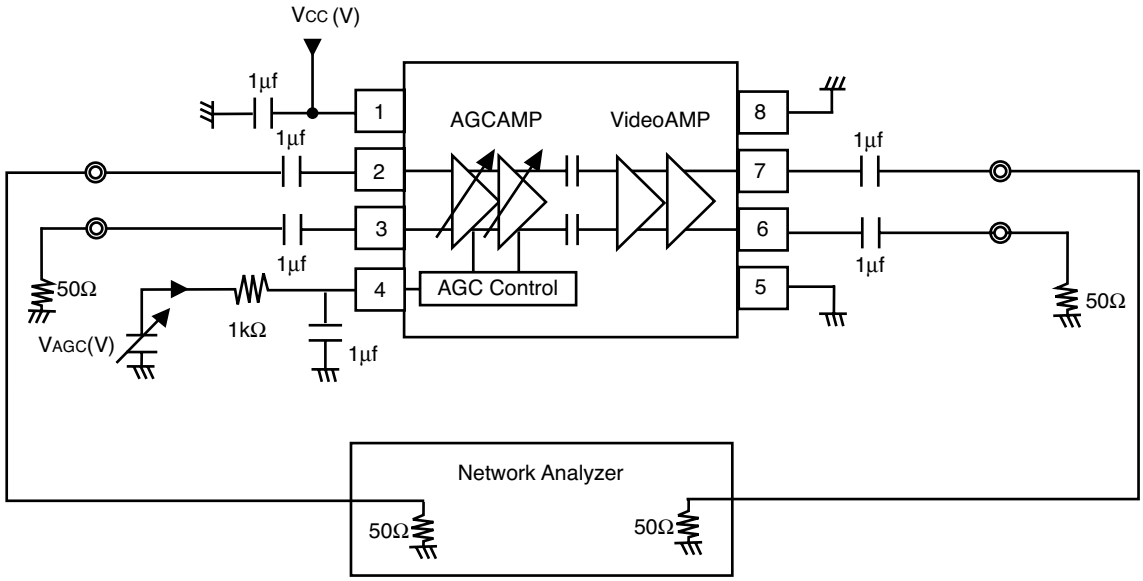
Note: Balun Transformer : TOKO 617DB-1010 B4F (Double balanced type)

MEASUREMENT CIRCUIT 3



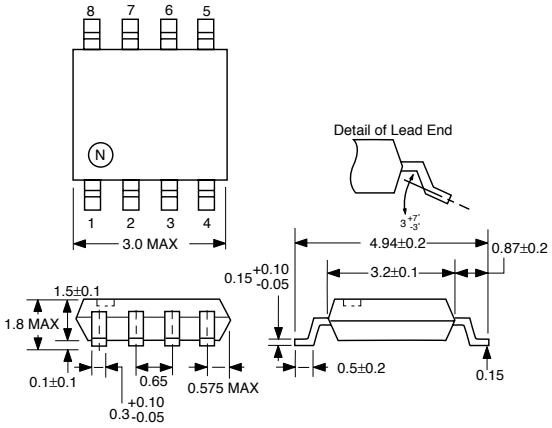
Note: Balun Transformer : TOKO 617DB-1010 B4F (Double balanced type)

MEASUREMENT CIRCUIT 4



OUTLINE DIMENSIONS (Units in mm)

PACKAGE OUTLINE S08



All dimensions are typical unless specified otherwise.

ORDERING INFORMATION

PART NUMBER	QUANTITY
UPC3221GV-E1-A	1 kp/reel

Note:
Embossed tape 8 mm wide. Pin 1 indicates pull-out direction of tape.

CEL California Eastern Laboratories

4590 Patrick Henry Drive
Santa Clara, CA 95054-1817
Telephone: (408) 919-2500
Facsimile: (408) 988-0279

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
Lead (Pb)	< 1000 PPM	-A	-AZ
		Not Detected	(*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.